

1MBI150VA-120L-50

IGBT Modules

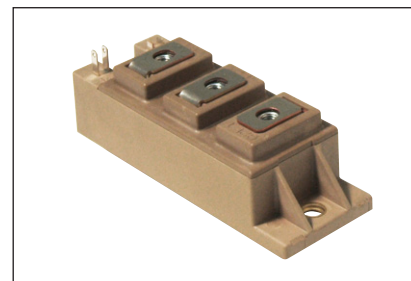
IGBT MODULE (U series) 1200V / 150A / 1 in one package

■ Features

- High speed switching
- Voltage drive
- Low Inductance module structure

■ Applications

- Inverter DB for Motor Drive
- AC and DC Servo Drive Amplifier (DB)
- Active PFC
- Industrial machines



■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings (at $T_c=25^{\circ}\text{C}$ unless otherwise specified)

Items		Symbols	Conditions	Maximum ratings	Units	
Collector-Emitter voltage		V _{CES}		1200	V	
Gate-Emitter voltage		V _{GES}		±20	V	
Collector current		I _C	Continuous T _C =100°C	150	A	
		I _{C pulse}	1ms	300		
		-I _C		75		
		-I _{C pulse}	1ms	150		
Collector power dissipation		P _C	1 device	785	W	
Reverse voltage for FWD		V _R		1200	V	
Forward current for FWD		I _F		200	A	
		I _{F pulse}	1ms	400		
Junction temperature		T _J		175	°C	
Operating junction temperature (under switching conditions)		T _{jop}		150		
Case temperature		T _C		125		
Storage temperature		T _{stg}		-40~125		
Isolation voltage	Between terminal and copper base (*1)		V _{Iso}	AC : 1min.	2500	VAC
Screw torque	Mounting (*2)	-		5.0	N m	
	Terminals (*3)					

Note *1: All terminals should be connected together when isolation test will be done.

Note *2: Recommendable Value : 3.0 to 5.0 N·m (M5 or M6)

Note *3: Recommendable Value : 2.5 to 5.0 N·m (M5)

● Electrical characteristics (at T_j = 25°C unless otherwise specified)

Items	Symbols	Conditions		Characteristics			Units
				min.	typ.	max.	
Zero gate voltage collector current	I _{CEs}	V _{GE} = 0V, V _{CE} = 1200V		-	-	1.0	mA
Gate-Emitter leakage current	I _{GES}	V _{CE} = 0V, V _{GE} = ±20V		-	-	200	nA
Gate-Emitter threshold voltage	V _{GE(th)}	V _{CE} = 20V, I _C = 150mA		6.0	6.5	7.0	V
Collector-Emitter saturation voltage	V _{CE(sat)} (terminal)	V _{GE} = 15V I _C = 150A	T _J =25°C	-	1.95	2.40	V
			T _J =125°C	-	2.30	-	
			T _J =150°C	-	2.35	-	
	V _{CE(sat)} (chip)		T _J =25°C	-	1.85	2.30	
			T _J =125°C	-	2.20	-	
			T _J =150°C	-	2.25	-	
Internal gate resistance	R _{G(int)}	-		-	5	-	Ω
Input capacitance	C _{ies}	V _{GE} = 0V, V _{CE} = 10V, f = 1MHz		-	12.6	-	nF
Turn-on time	t _{on}	V _{CC} = 600V, I _C = 150A V _{GE} = ±15V, R _G = 1.1Ω T _J = 150°C, R _S = 30nH		-	600	-	nsec
	t _r			-	200	-	
	t _{r(l)}			-	50	-	
Turn-off time	t _{off}			-	600	-	
	t _f			-	40	-	
Forward on voltage	V _F (terminal)	V _{GE} = 0V I _F = 75A	T _J =25°C	-	1.80	2.25	V
			T _J =125°C	-	1.95	-	
			T _J =150°C	-	1.90	-	
	V _F (chip)		T _J =25°C	-	1.70	2.15	
			T _J =125°C	-	1.85	-	
			T _J =150°C	-	1.80	-	
Reverse Current	I _R	V _{CE} = 1200V		-	-	1.0	mA
Forward on voltage	V _F (terminal)	V _{GE} = 0V I _F = 200A	T _J =25°C	-	1.85	2.30	V
			T _J =125°C	-	2.00	-	
			T _J =150°C	-	1.95	-	
	V _F (chip)		T _J =25°C	-	1.70	2.15	
			T _J =125°C	-	1.85	-	
			T _J =150°C	-	1.80	-	
Reverse recovery time	t _{rr}	I _F = 200A		-	-	0.35	μs

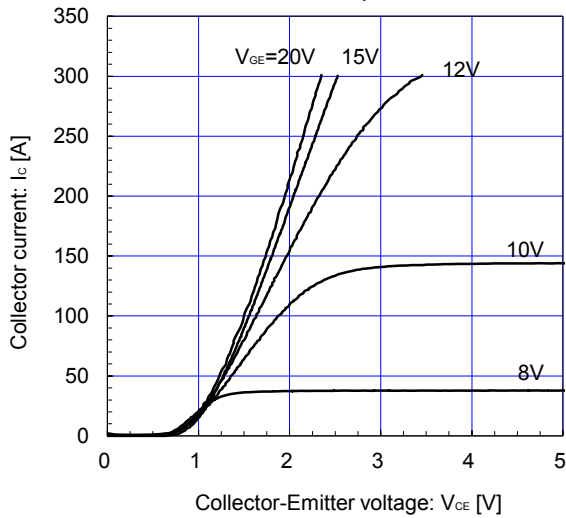
● Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal resistance (1device)	R _{th(j-c)}	IGBT	-	-	0.19	°C/W
		Inverse Diode	-	-	0.58	
		FWD	-	-	0.24	
Contact thermal resistance (1device) (*4)	R _{th(c-f)}	with Thermal Compound	-	0.050	-	

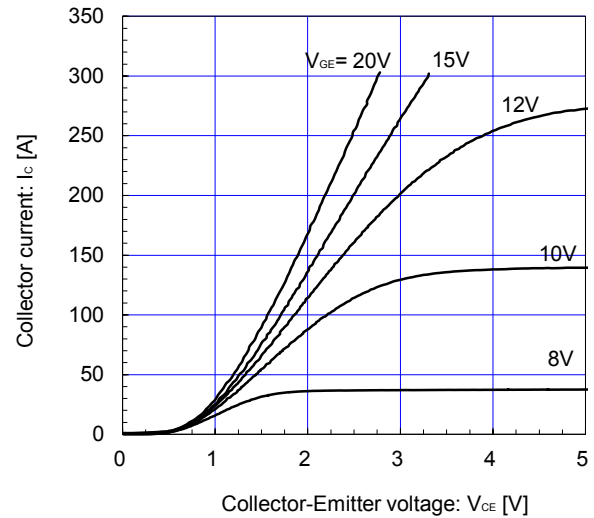
Note *4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Characteristics (Representative)

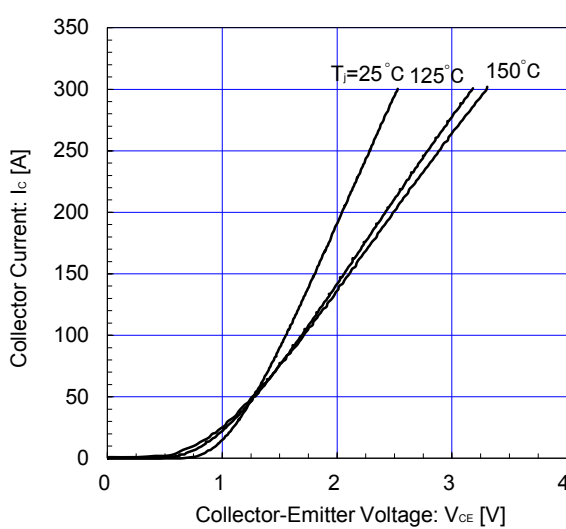
Collector current vs. Collector-Emittter voltage (typ.)
 $T_J = 25^\circ\text{C}$ / chip



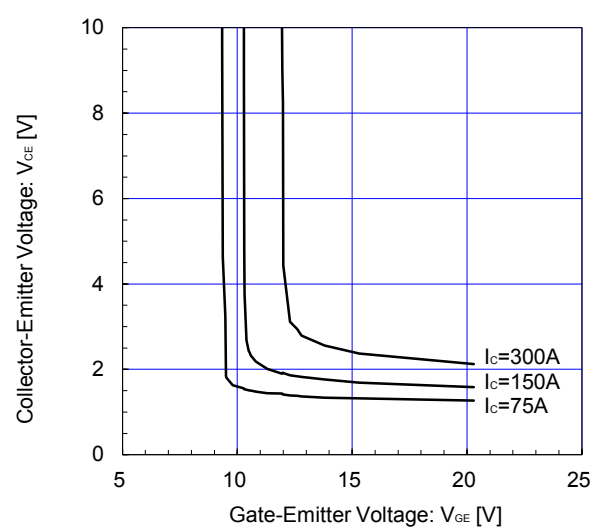
Collector current vs. Collector-Emittter voltage (typ.)
 $T_J = 150^\circ\text{C}$ / chip



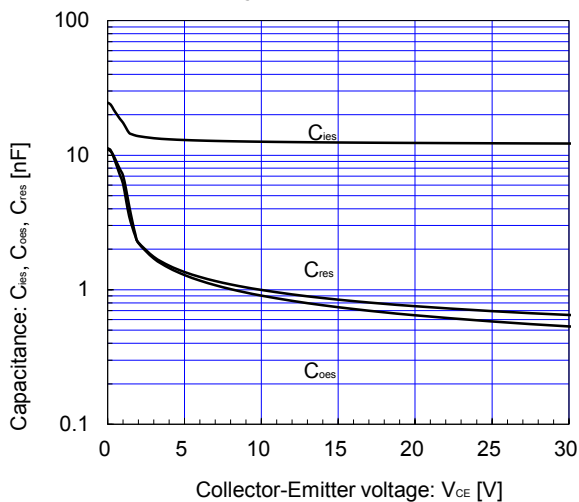
Collector current vs. Collector-Emittter voltage (typ.)
 $V_{GE} = 15\text{V}$ / chip



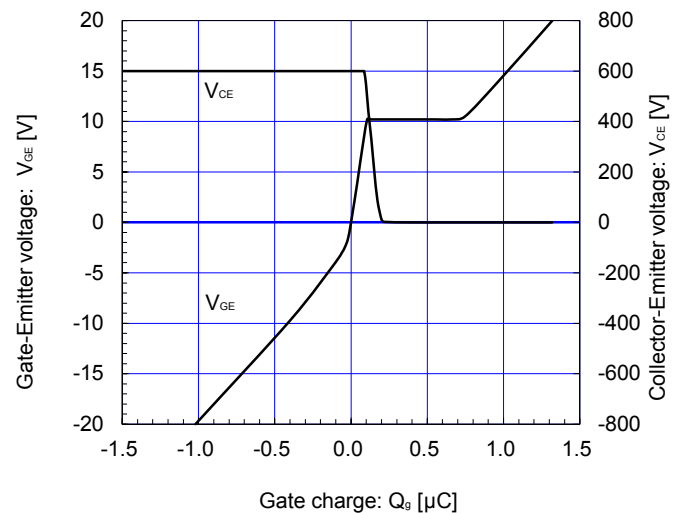
Collector-Emittter voltage vs. Gate-Emittter voltage
 $T_J = 25^\circ\text{C}$ / chip



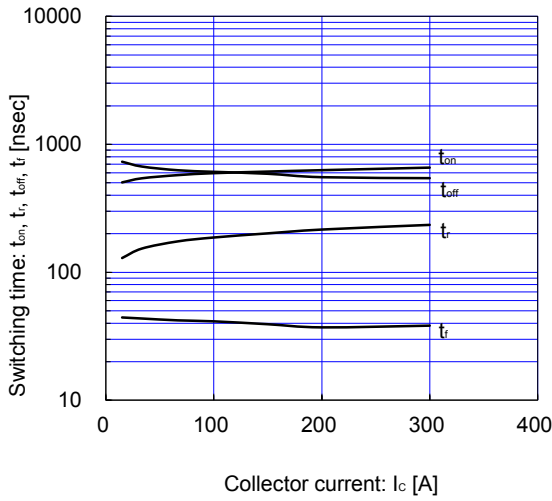
Capacitance vs. Collector-Emittter Voltage (typ.)
 $V_{GE} = 0\text{V}$, $f = 1\text{MHz}$, $T_J = 25^\circ\text{C}$



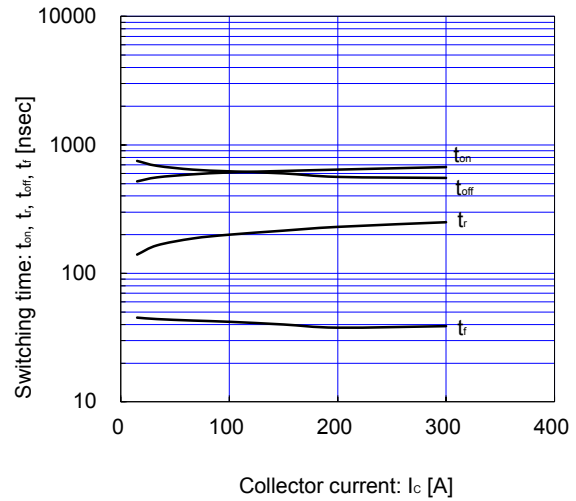
Dynamic Gate Charge (typ.)
 $V_{CC} = 600\text{V}$, $I_C = 200\text{A}$, $T_J = 25^\circ\text{C}$



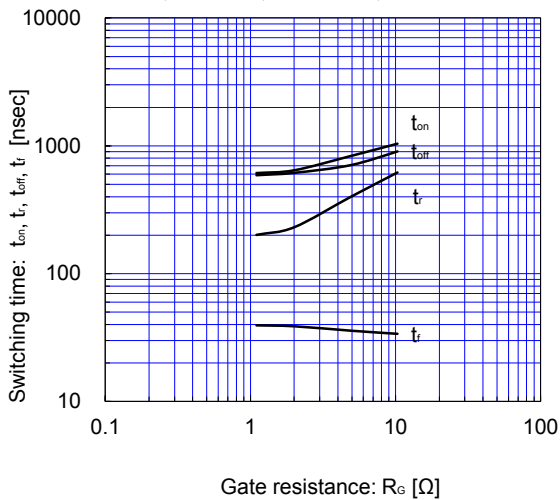
Switching time vs. Collector current (typ.)
 $V_{CC}=600V$, $V_{GE}=\pm 15V$, $R_G=1.1\Omega$, $T_J=125^\circ C$



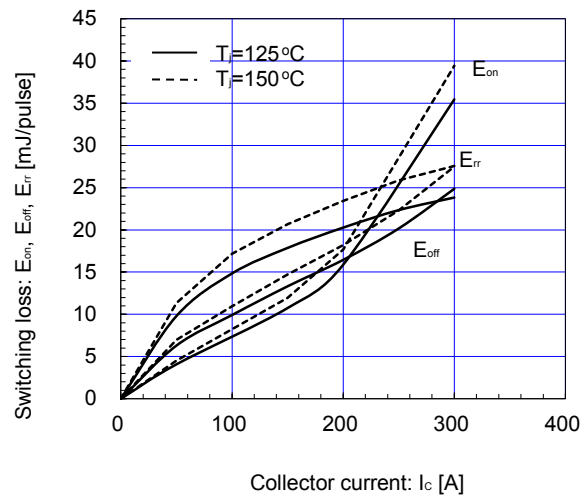
Switching time vs. Collector current (typ.)
 $V_{CC}=600V$, $V_{GE}=\pm 15V$, $R_G=1.1\Omega$, $T_J=150^\circ C$



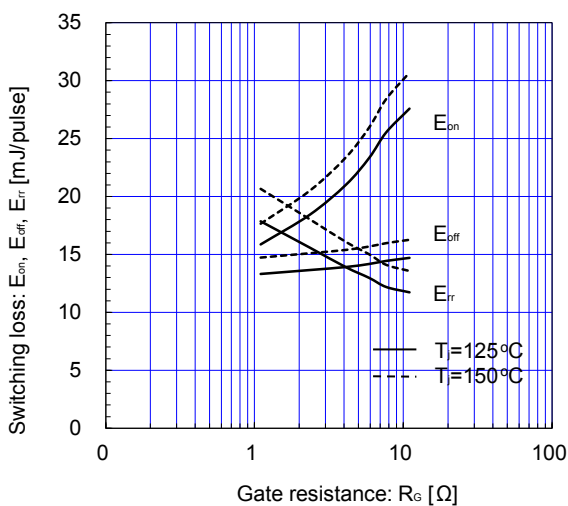
Switching time vs. Gate resistance (typ.)
 $V_{CC}=600V$, $I_C=150A$, $V_{GE}=\pm 15V$, $T_J=125^\circ C$



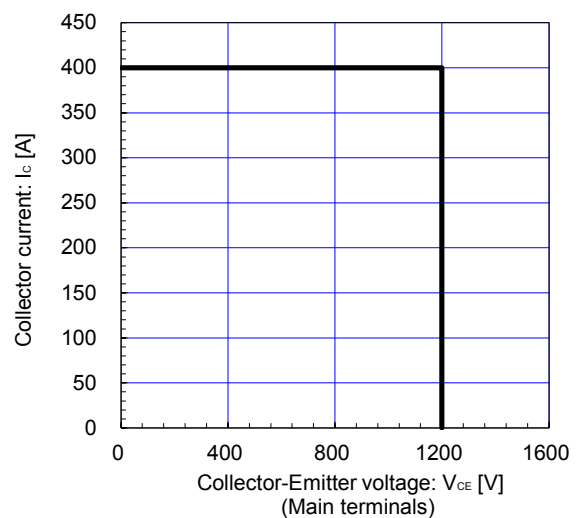
Switching loss vs. Collector current (typ.)
 $V_{CC}=600V$, $V_{GE}=\pm 15V$, $R_G=1.1\Omega$, $T_J=125, 150^\circ C$

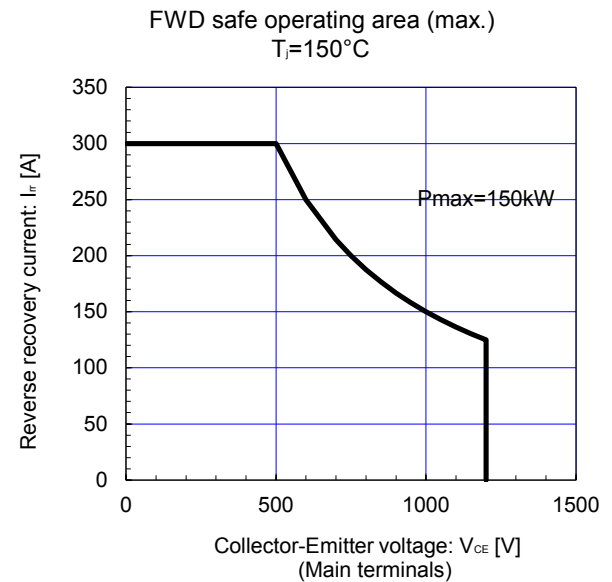
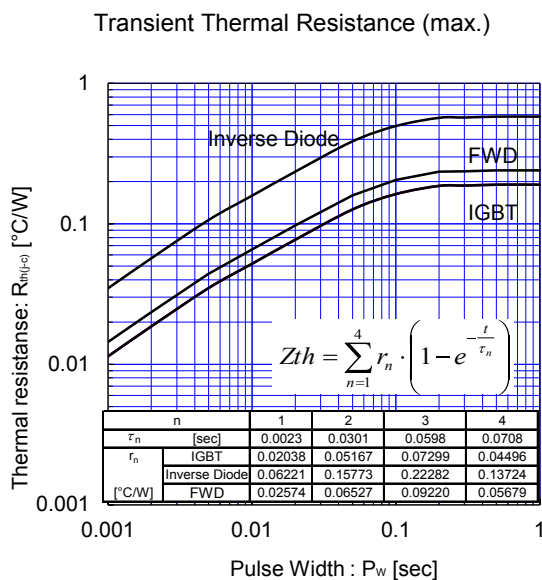
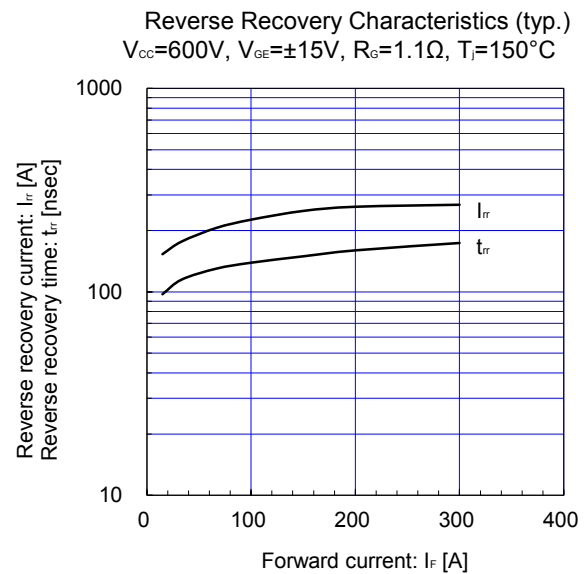
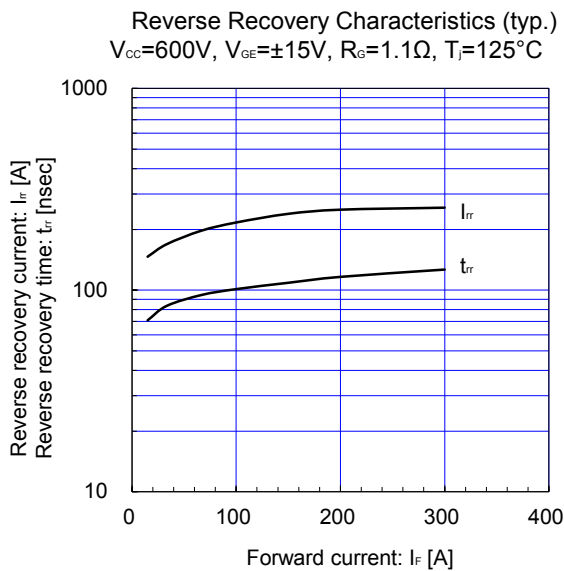
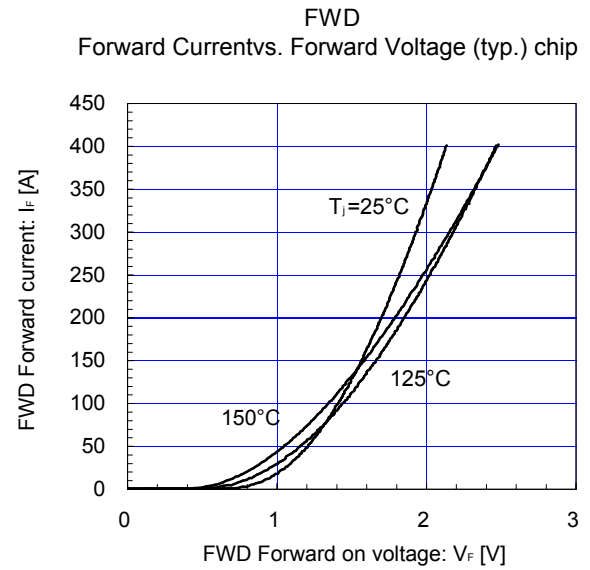
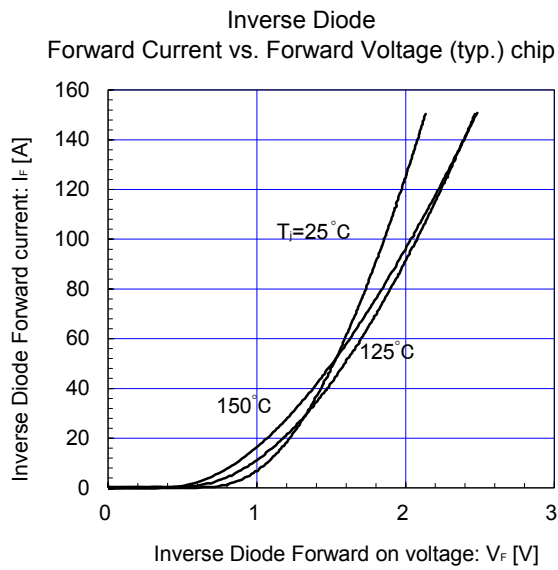


Switching loss vs. Gate resistance (typ.)
 $V_{CC}=600V$, $I_C=150A$, $V_{GE}=\pm 15V$, $T_J=125, 150^\circ C$

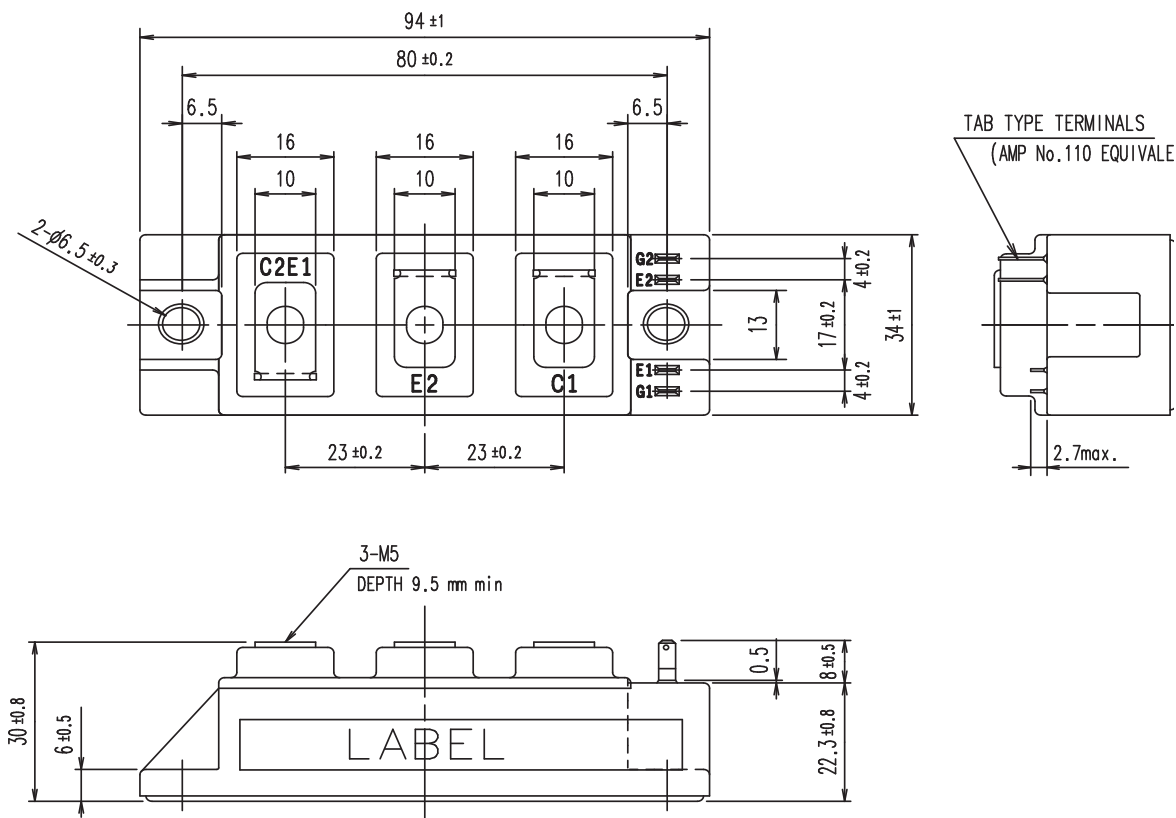


Reverse bias safe operating area (max.)
 $+V_{GE}=15V$, $-V_{GE}=15V$, $R_G=1.1\Omega$, $T_J=150^\circ C$

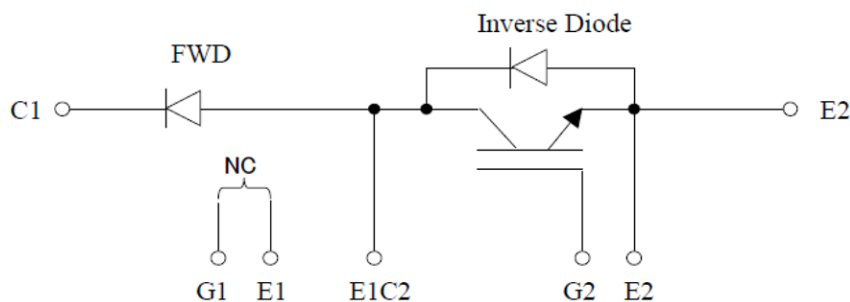




Outline Drawings, mm



Equivalent Circuit Schematic



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